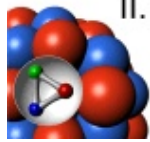
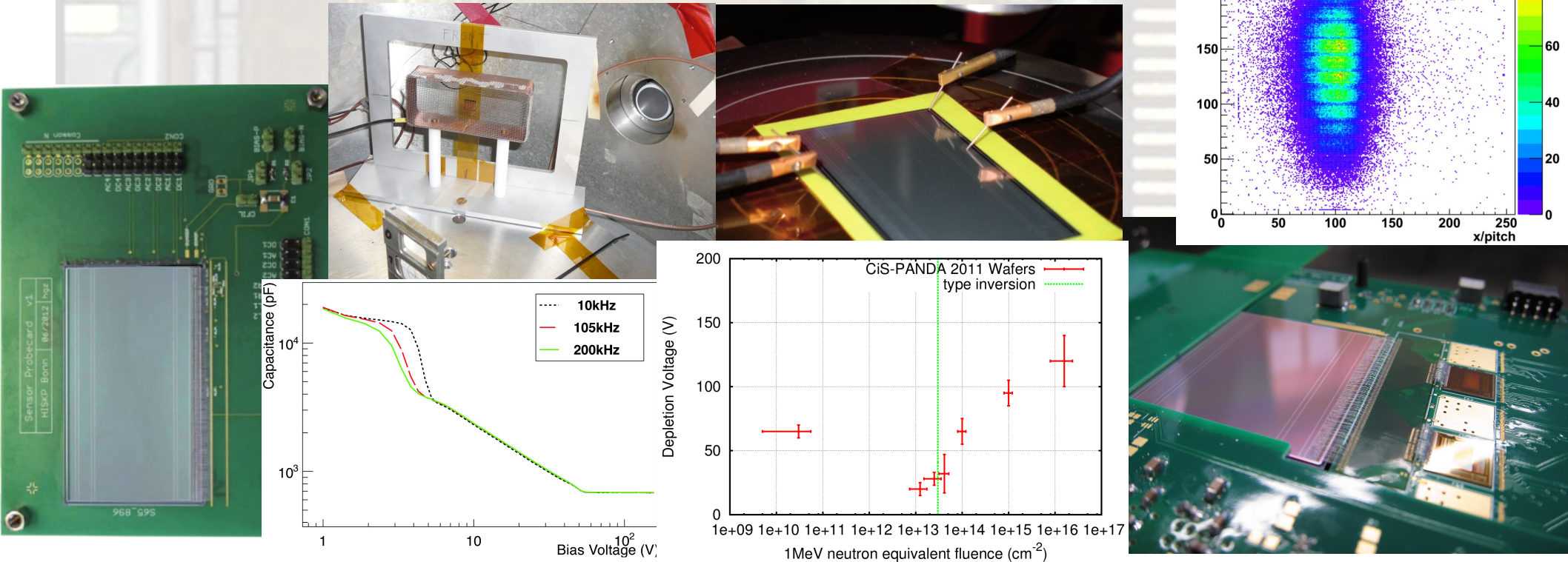


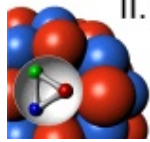
Updates on the MVD-Strip-Detector



Detector Development

- barrel sensors been intensively tested
 - new engineering run submitted beginning 2013
- investigate different biasing method

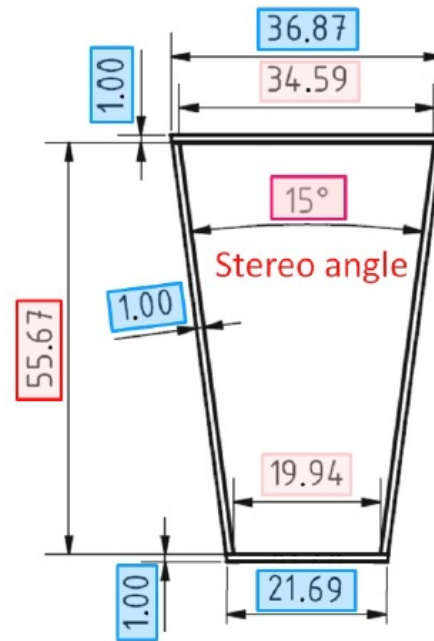




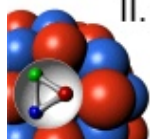
Detector Development

- disk sensors engineering run arrived @Jülich
- CiS Erfurt, same technology as barrel sensors

strip implants:	512 p ⁺ -strips in n-substrat and 512 n ⁺ -strips for the backside.
Strip orientation:	parallel to the long sensor edges, skew angle = 15°
pitch:	67.5 μm
Biasing:	punch-through
n-side charge sep:	p-spray
height:	57.67 mm
thickness:	250 – 300 μm

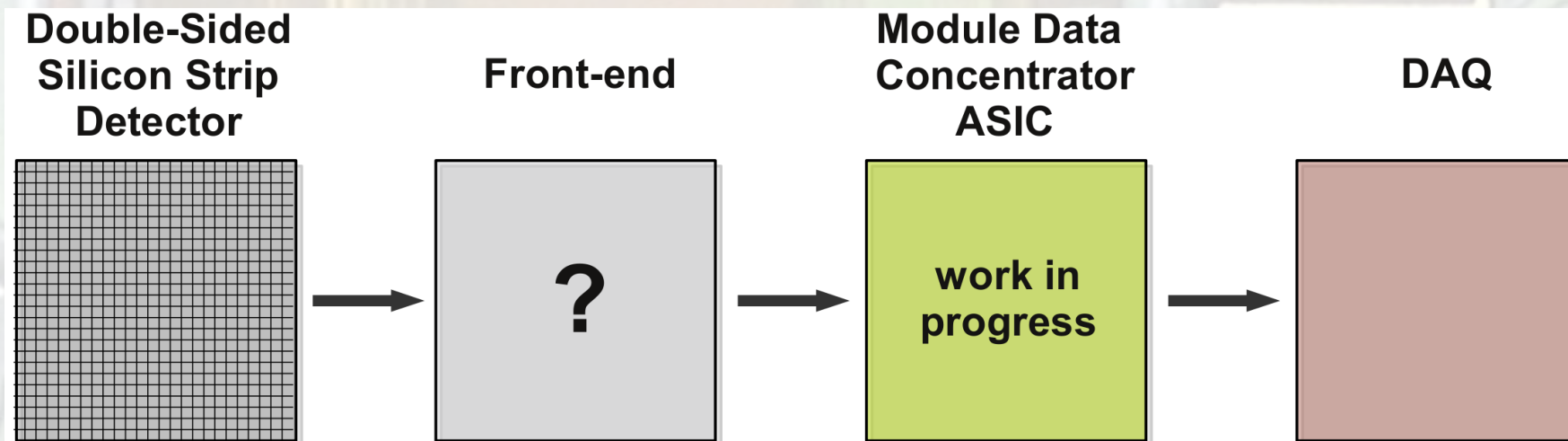


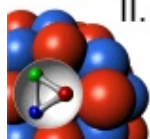
MVD group Jülich



Front-end Status

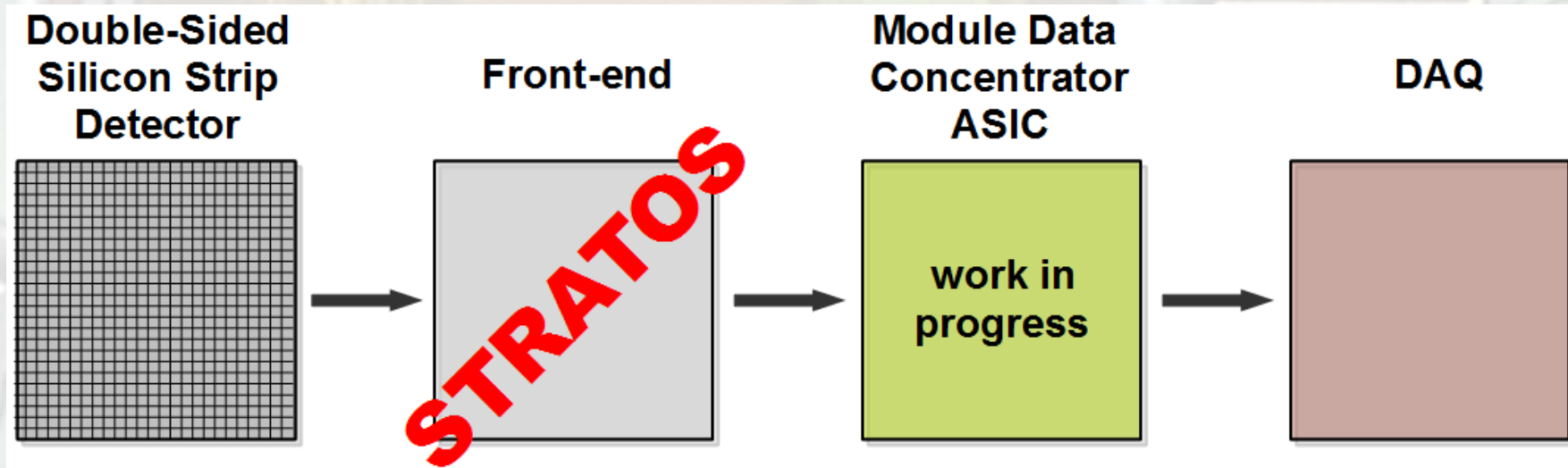
- decision for the strip detector front-end made
- based on TOFPET ASIC (EndoTOFPET-US coll.)
- modifications towards silicon strip detectors already started at INFN Torino

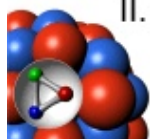




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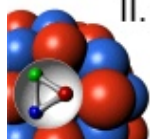




Front-end Features

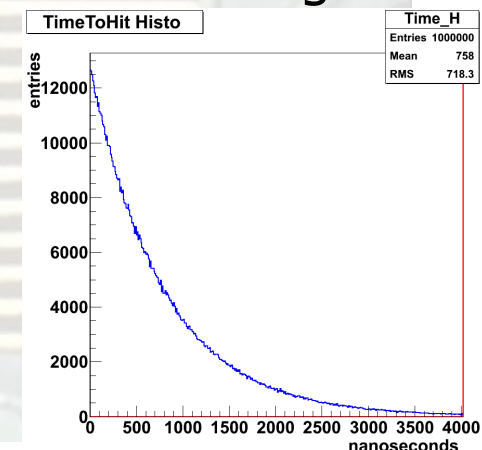
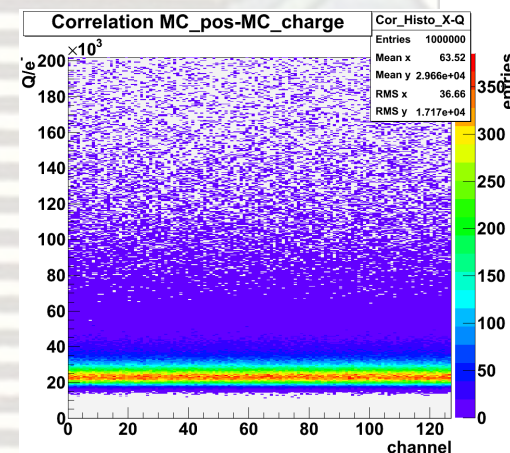
- self-triggering, fully digital data output
- analog part customized to sensor capacitance
- short ToT to avoid pile-up
- fast sampling (binning $\sim 100\text{ps}$)
 - using TDCs based on time interpolation
- high digitization resolution
 - clustering to improve spacial resolution
 - energy loss information as additional PID input

MVD group Turin

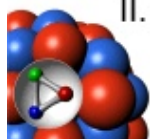


Strip Front-end Simulation

- fast and flexible using C++ and Root to compare with VHDL simulations
- Features (so far):
 - adjustable number of channels (64 vs. 128)
 - adjustable sensor thickness (charge)
 - uniform distribution in position, landau distribution in charge
 - double strip hit with charge sharing (CoG)
 - exponential distribution in time
 - wave-form from device simulation
 - ... work in progress

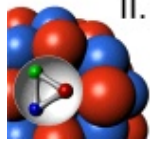


MVD group Gießen



MVD Strip-Detector count

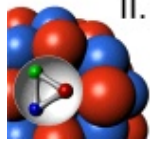
	Barrel Part	Disk Part	Sum
Sensors	184 rectangular 64 square	48 trapezoidal	296
Front-ends	2536 (64 ch)	768 (64 ch)	3304
DC-DCs	1240	240	1480
MDCs	248	48	296



Gießen Infrastructure

- installed beginning of April
- size: 3,00 x 3,50 m², internal height: 2,20 m
- approx. 10m² clean room space
- designed for ISO 6
- measured to comply better then ISO 6

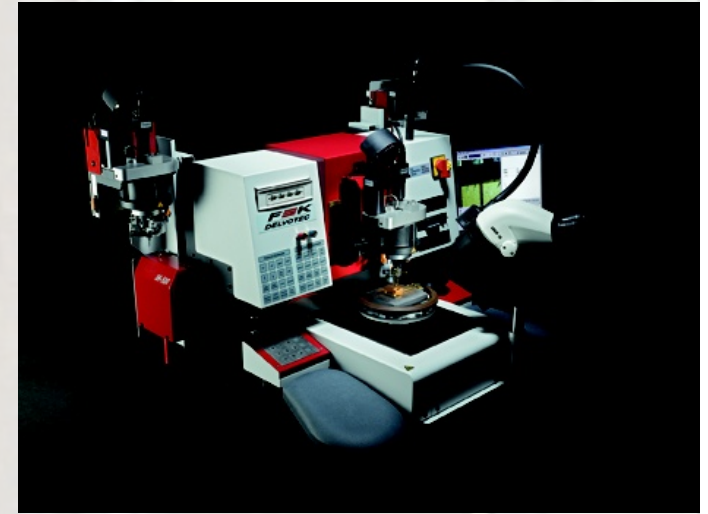




Gießen Infrastructure



bonding machine:
F&K Delvotec 5630
already in Gießen
will be assembled soon

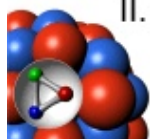


PA200BlueRay

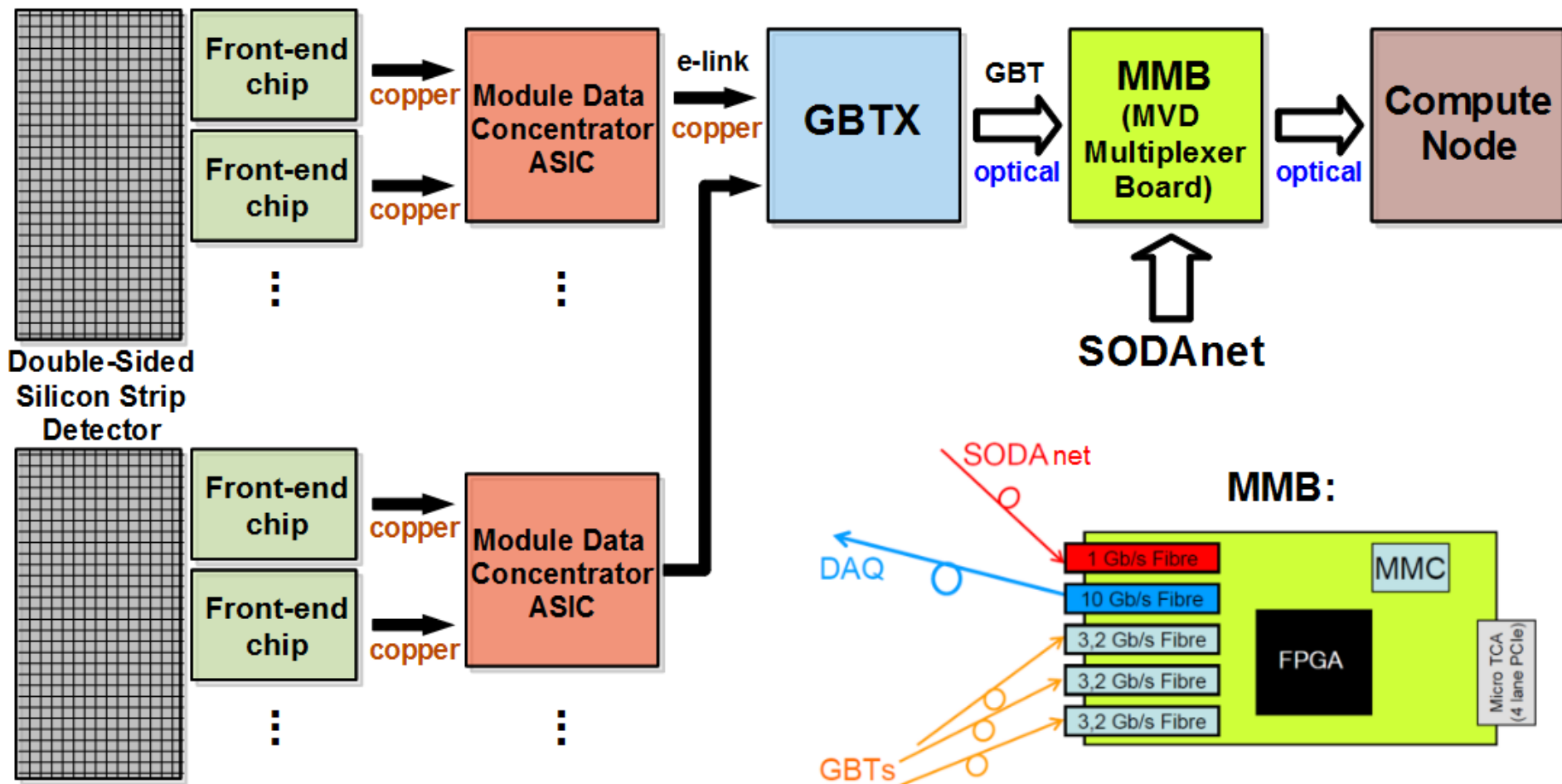
200 mm Semi-Automatic Probe System
with BlueRay Technology

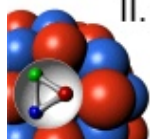


wafer prober:
Cascade Microtech PA200BlueRay
ordered



Strip-DAQ-Chain

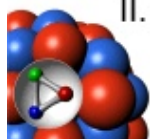




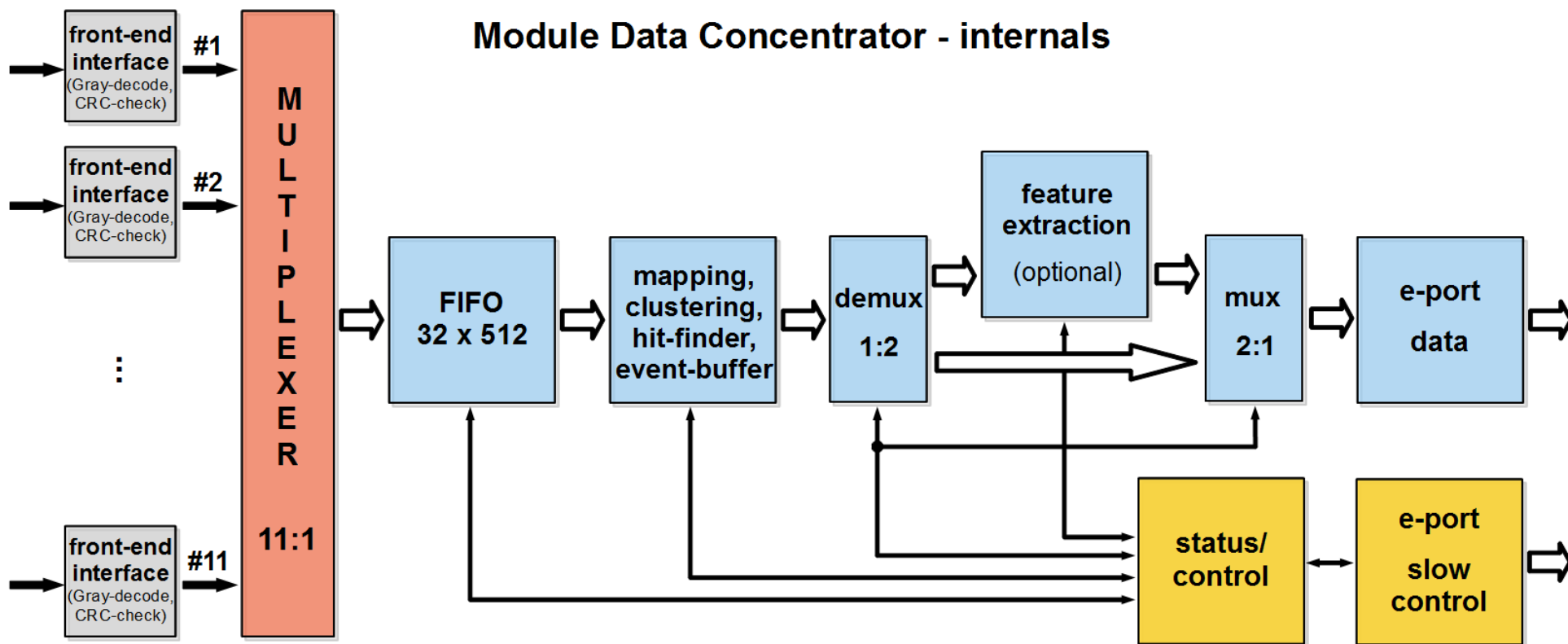
Module Data Concentrator

- all front-ends of one strip sensor connected to one module data concentrator ASIC (MDC)
- front-end data:
 - strip address
 - time information
 - ToT
- e-links (GBT) will be used for data transfer and slow control

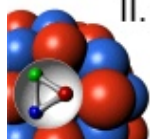
H. Sohlbach, FH Iserlohn



Module Data Concentrator



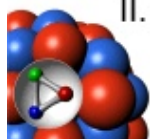
H. Sohlbach, FH Iserlohn



Module Data Concentrator

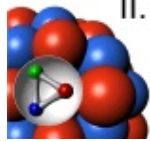
- Status as of April 2013
 - design versions: with/without feature extraction
 - design & simulation of FPGA prototype (VHDL-based) finished for:
11:1 multiplexer, FIFO, clustering/hit finding
 - in design/redesigning:
triple redundancy, clustering/hit finding, e-link, status/control
 - work on the specification of the front-end/module controller interface in progress

H. Sohlbach, FH Iserlohn



Summary

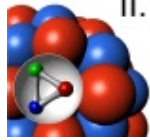
- strip front-end in development
 - MDC in development
- => both developed for the specific requirements of the PANDA MVD
- feature set customized to our requirements
 - no dependence on external developments



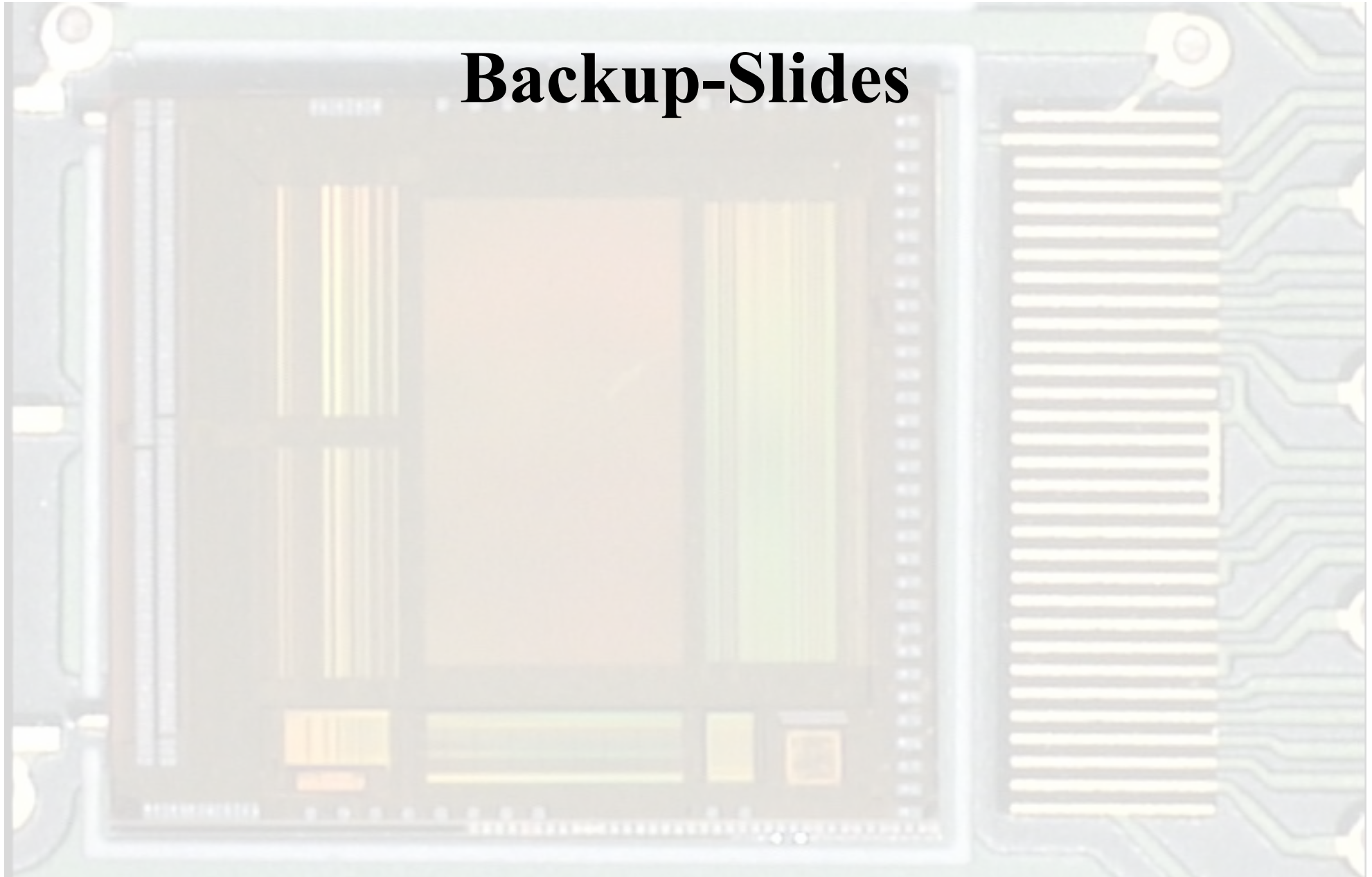
Thank you for your attention

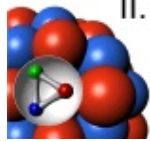
STRATOS = **ST**rip **R**eadout **ASIC TO**rino **S**olution
(Lancia Stratos)





Backup-Slides





Pile-up

• short ToT to avoid pile-up: $P_{pile-up} = 1 - e^{(-\dot{N}_{chn} \cdot t_{ToT})}$

assuming 36ns ToT (5fC \sim 1 MIP in a single strip):

P(pile-up) = 0.036% @ 10kHz channel hit rate (SF=1)

P(pile-up) = 0.072% @ 20kHz channel hit rate (SF=2)

P(pile-up) = 0.144% @ 40kHz channel hit rate (SF=4)

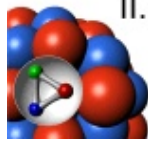
assuming 60ns ToT (10fC \sim 2 MIP in a single strip):

P(pile-up) = 0.06% @ 10kHz channel hit rate (SF=1)

P(pile-up) = 0.12% @ 20kHz channel hit rate (SF=2)

P(pile-up) = 0.24% @ 40kHz channel hit rate (SF=4)

(ToT based on device simulation from Valentino)



Gießen Infrastructure

